FAIRCHILD SEMICONDUCTOR®

September 2011

NC7SZ57 / NC7SZ58 TinyLogic® UHS Universal Configurable Two-Input Logic Gates

Features

- Ultra High Speed
- Capable of Implementing any Two-Input Logic Functions
- Typical Usage Replaces Two (2) TinyLogic® Gate Devices
- Reduces Part Counts in Inventory
- Broad V_{CC} Operating Range: 1.65V to 5.5V
- Power Down High Impedance Input/Output
- Over-Voltage Tolerant Inputs Facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry Implemented

Description

The NC7SZ57 and NC7SZ58 are universal configurable two-input logic gates. Each device is capable of being configured for 1 of 5 unique two-input logic functions. Any possible two-input combinatorial logic function can be implemented, as shown in the *Function Selection Table*. Device functionality is selected by how the device is wired at the board level. *Figures 4 through 13* illustrate how to connect the NC7SZ57 and NC7SZ58, respectively, for the desired logic function. All inputs have been implemented with hysteresis.

The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} operating range. The input and output are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 5.5V independent of V_{CC} operating range.

Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7SZ57P6X	Z57	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ57L6X	KK	6-Lead Micropak™, 1.0mm Wide	5000 Units on Tape & Reel
NC7SZ57FHX	KK	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	
NC7SZ58P6X	Z58	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ58L6X	LL	6-Lead Micropak™, 1.0mm Wide	5000 Units on Tape & Reel
NC7SZ58FHX	LL	6-Lead, MicroPak2™ , 1x1mm Body, .35mm Pitch	

Pin Configurations

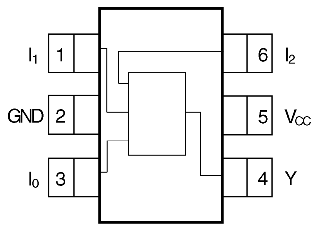


Figure 1. SC70 (Top View)

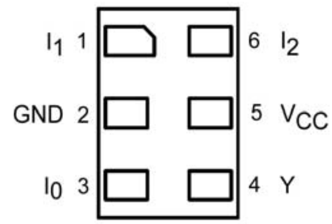


Figure 2. MicroPak™ (Top Through View)

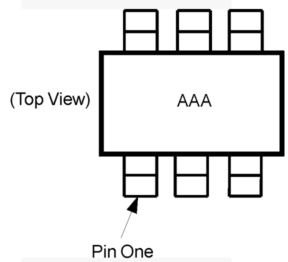


Figure 3. Pin 1 Orientation

Notes:

1. AAA represents product code top mark (*see Ordering Information*).
2. Orientation of top mark determines pin one location.
3. Reading the top mark left to right, pin one is the lower left pin.

Pin Definitions

Pin # SC70	Pin # MicroPak™	Name	Description
1	1	I_1	Data Input
2	2	GND	Ground
3	3	I_0	Data Input
4	4	Y	Output
5	5	V_{CC}	Supply Voltage
6	6	I_2	Data Input

Function Table

Inputs			NC7SZ57	NC7SZ58
I_2	I_1	I_0	$Y = \overline{(I_0)} \bullet \overline{(I_2)} + (I_1) \bullet (I_2)$	$Y = (I_0) \bullet \overline{(I_2)} + \overline{(I_1)} \bullet (I_2)$
L	L	L	H	L
L	L	H	L	H
L	H	L	H	L
L	H	H	L	H
H	L	L	L	H
H	L	H	L	H
H	H	L	H	L
H	H	H	H	L

H = HIGH Logic Level
L = LOW Logic Level

Function Selection Table

2-Input Logic Function	Device Selection	Connection Configuration
2-Input AND	NC7SZ57	Figure 4
2-Input AND with Inverted Input	NC7SZ58	Figure 10, Figure 11
2-Input AND with Both Inputs Inverted	NC7SZ57	Figure 7
2-Input NAND	NC7SZ58	Figure 9
2-Input NAND with Inverted Input	NC7SZ57	Figure 5, Figure 6
2-Input NAND with Both Inputs Inverted	NC7SZ58	Figure 12
2-Input OR	NC7SZ58	Figure 12
2-Input OR with Inverted Input	NC7SZ57	Figure 5, Figure 6
2-Input OR with Both Inputs Inverted	NC7SZ58	Figure 9
2-Input NOR	NC7SZ57	Figure 7
2-Input NOR with Inverted Input	NC7SZ58	Figure 9, Figure 10
2-Input NOR with Both Inputs Inverted	NC7SZ57	Figure 4
2-Input XOR	NC7SZ58	Figure 13
2-Input XNOR	NC7SZ57	Figure 8

NC7SZ57 Logic Configurations

Figure 4 through Figure 8 show the logical functions that can be implemented using the NC7SZ57. The diagrams show the DeMorgan's equivalent logic duals for a given two-input function. The logical implementation is next to the board-level physical implementation of how the pins of the function should be connected.

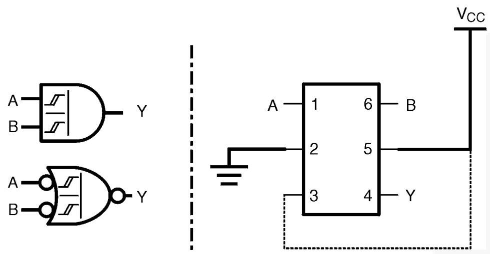


Figure 4. 2-Input AND Gate

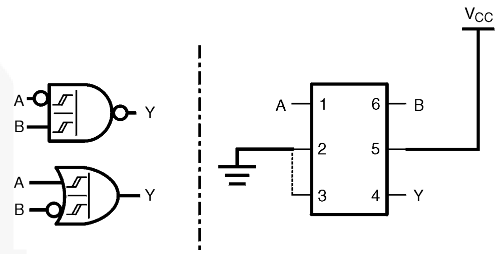


Figure 5. 2-Input NAND with Inverted A Input

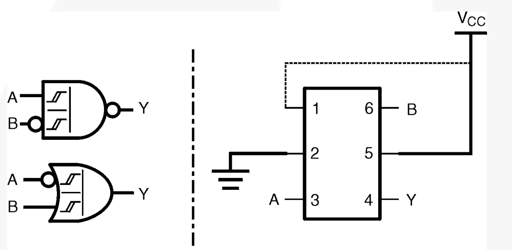


Figure 6. 2-Input NAND with Inverted B Input

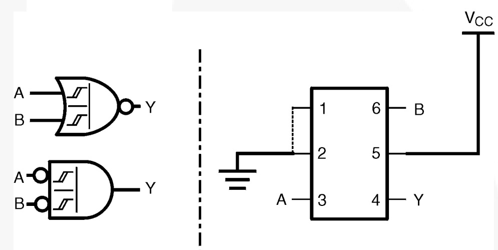


Figure 7. 2-Input NOR Gate

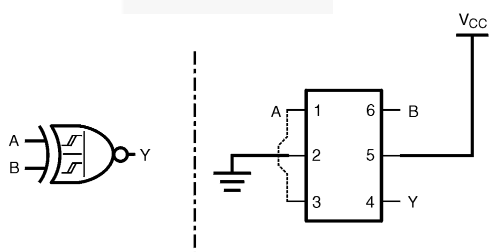


Figure 8. 2-Input XNOR Gate

NC7SZ58 Logic Configurations

Figure 9 through Figure 13 show the logical functions that can be implemented using the NC7SZ58. The diagrams show the DeMorgan's equivalent logic duals for a given two-input function. The logical implementation is next to the board-level physical implementation of how the pins of the function should be connected.

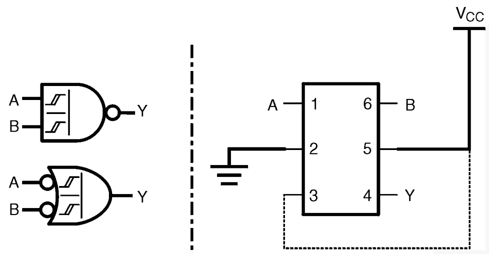


Figure 9. 2-Input NAND Gate

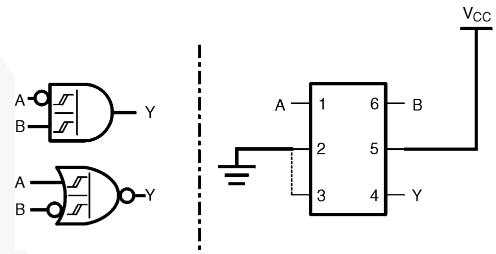


Figure 10. 2-Input AND with Inverted A Input

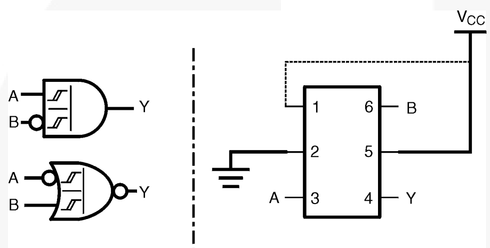


Figure 11. 2-Input AND with Inverted B Input

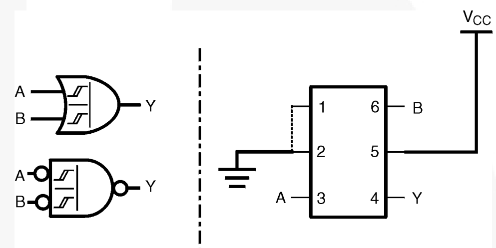


Figure 12. 2-Input OR Gate

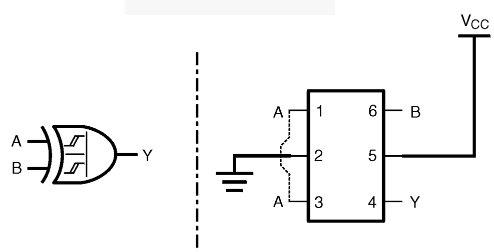


Figure 13. 2-Input XOR Gate

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Units
V_{CC}	Supply Voltage		-0.5	7.0	V
V_{IN}	DC Input Voltage		-0.5	7.0	V
V_{OUT}	DC Output Voltage		-0.5	7.0	V
I_{IK}	DC Input Diode Current	V_{IN} < 0.5V		-50	mA
I_{OK}	DC Output Diode Current	V_{OUT} < -0.5V		-50	mA
I_{OUT}	DC Output Source / Sink Current			±50	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current			±50	mA
T_{STG}	Storage Temperature Range		-65	+150	°C
T_J	Maximum Junction Temperature under Bias			+150	°C
T_L	Lead Temperature, Soldering 10 Seconds			+260	°C
P_D	Power Dissipation at +85°C	MicroPak™-6		130	mW
		SC70-6		180	
		MicroPak2™-6		120	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	V
	Charged Device Model, JEDEC:JESD22-C101			2000	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Units
V_{CC}	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.5	5.5	
V_{IN}	Input Voltage		0	5.5	V
V_{OUT}	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature		-40	+85	°C
θ_{JA}	Thermal Resistance	SC70-6		350	°C/W
		MicroPak™-6		500	
		MicroPak2™-6		560	

DC Electrical Characteristics

Symbol	Parameter	V_{CC}	Conditions		T_A=+25°C Min.	T_A=+25°C Typ.	T_A=+25°C Max.	T_A=-40 to +85°C Min.	T_A=-40 to +85°C Max.	Units
V_P	Positive Threshold Voltage	1.65			0.60	0.99	1.40	0.60	1.40	V
		2.30			1.00	1.39	1.80	1.00	1.80	
		3.00			1.30	1.77	2.20	1.30	2.20	
		4.50			1.90	2.49	3.10	1.90	3.10	
		5.50			2.20	2.95	3.60	2.20	3.60	
V_N	Negative Threshold Voltage	1.65			0.20	0.50	0.90	0.20	0.90	V
		2.30			0.40	0.75	1.15	0.40	1.15	
		3.00			0.60	0.99	1.50	0.60	1.50	
		4.50			1.00	1.43	2.00	1.00	2.00	
		5.50			1.20	1.70	2.30	1.20	2.30	
V_H	Hysteresis Voltage	1.65			0.15	0.48	0.90	0.15	0.90	V
		2.30			0.25	0.64	1.10	0.25	1.10	
		3.00			0.40	0.78	1.20	0.40	1.20	
		4.50			0.60	1.06	1.50	0.60	1.50	
		5.50			0.70	1.25	1.70	0.70	1.70	
V_{OH}	HIGH Level Output Voltage	1.65	V_{IN}=V_{IH} or V_{IL} I_{OH}= -100µA		1.55	1.65		1.55		V
		2.30			2.20	2.30		2.20		
		3.00			2.90	3.00		2.90		
		4.50			4.40	4.50		4.40		
		1.65	V_{IN}=V_{IH} or V_{IL}	I_{OH}= -4mA	1.29	1.52		1.29		
		2.30		I_{OH}= -8mA	1.90	2.15		1.90		
		3.00		I_{OH}= -16mA	2.40	2.80		2.40		
		3.00		I_{OH}= -24mA	2.30	2.68		2.30		
		4.50		I_{OH}= -32mA	3.80	4.20		3.80		

Continued on the following page…

DC Electrical Characteristics (Continued)

Symbol	Parameter	V_{CC}	Conditions		T_A=+25°C			T_A=-40 to +85°C		Units
					Min.	Typ.	Max.	Min.	Max.	
V_{OL}	LOW Level Output Voltage	1.65	V_{IN}=V_{IH} or V_{IL} I_{OL}=100µA				0.10		0.10	V
		2.30					0.10		0.10	
		3.00					0.10		0.10	
		4.50					0.10		0.10	
		1.65	V_{IN}=V_{IH} or V_{IL}	I_{OL}=4mA		0.08	0.24		0.24	
		2.30		I_{OL}=8mA		0.10	0.30		0.30	
		3.00		I_{OL}=16mA		0.15	0.40		0.40	
		3.00		I_{OL}=24mA		0.22	0.55		0.55	
		4.50		I_{OL}=32mA		0.22	0.55		0.55	
I_{IN}	Input Leakage Current	0 to 5.50	V_{IN} = 5.5V, GND				±0.1		±1.0	µA
I_{OFF}	Power Off Leakage Current	0	V_{IN} or V_{OUT}= 5.5V				1		10	µA
I_{CC}	Quiescent Supply Current	1.65 to 5.5	V_{IN} = 5.5V, GND				1		10	µA

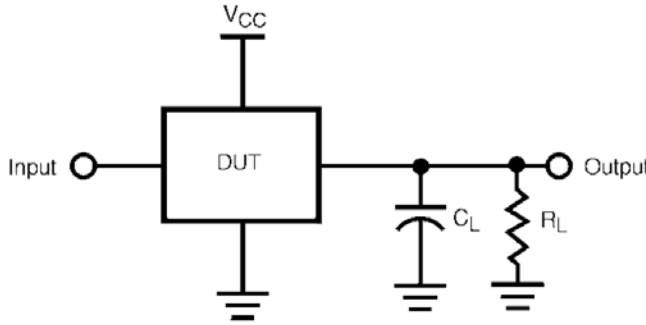
AC Electrical Characteristics

Symbol	Parameter	V_{CC}	Conditions	T_A=25°C			T_A=-40 to 85°C		Units	Figure
				Min.	Typ.	Max.	Min.	Max.		
t_{PHL}, t_{PLH}	Propagation Delay I_n to Y	1.8 ± 0.15	C_L=15pF, R_L=1MΩ	3.0	8.0	14.0	3.0	14.5	ns	Figure 14 Figure 16
		2.5 ± 0.2		1.5	4.9	8.0	1.5	8.5		
		3.3 ± 0.3		1.2	3.7	5.3	1.2	5.7		
		5.0 ± 0.5		0.8	2.8	4.3	0.8	4.6		
		3.3 ± 0.3	C_L=50pF, R_L=500Ω	1.5	4.2	6.0	1.5	6.5		
		5.0 ± 0.5		1.0	3.4	4.9	1.0	5.3		
C_{IN}	Input Capacitance	0			2				pF	
C_{PD}	Power Dissipation Capacitance	3.3	Note 4		14				pF	Figure 15
		5.0			17					

Note:

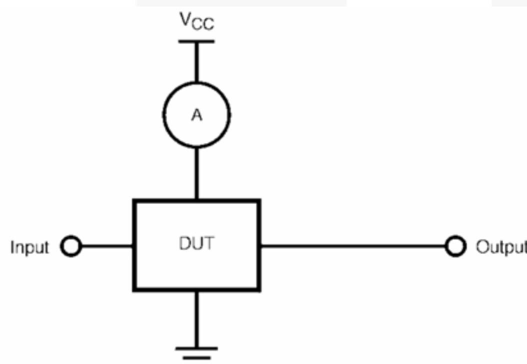
4. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. *(See Figure 12)* C_{PD} is related to I_{CCD} dynamic operatic current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{in}) + (I_{CCstatic})$.

AC Loadings and Waveforms



Note:
5. C_L includes load and stray capacitance.
6. Input PRR = 1.0MHz, t_W = 500ns.

Figure 14. AC Test Circuit



Note:
7. Input = AC waveforms.
8. PRR = Variable; Duty Cycle = 50%.

Figure 15. I_{CCD} Test Circuit

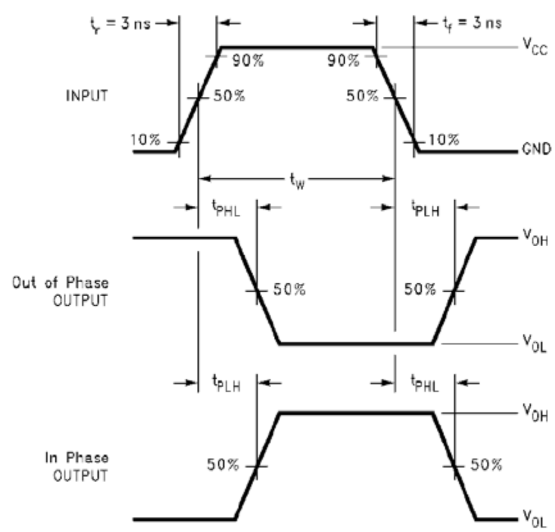


Figure 16. AC Waveforms

Physical Dimensions

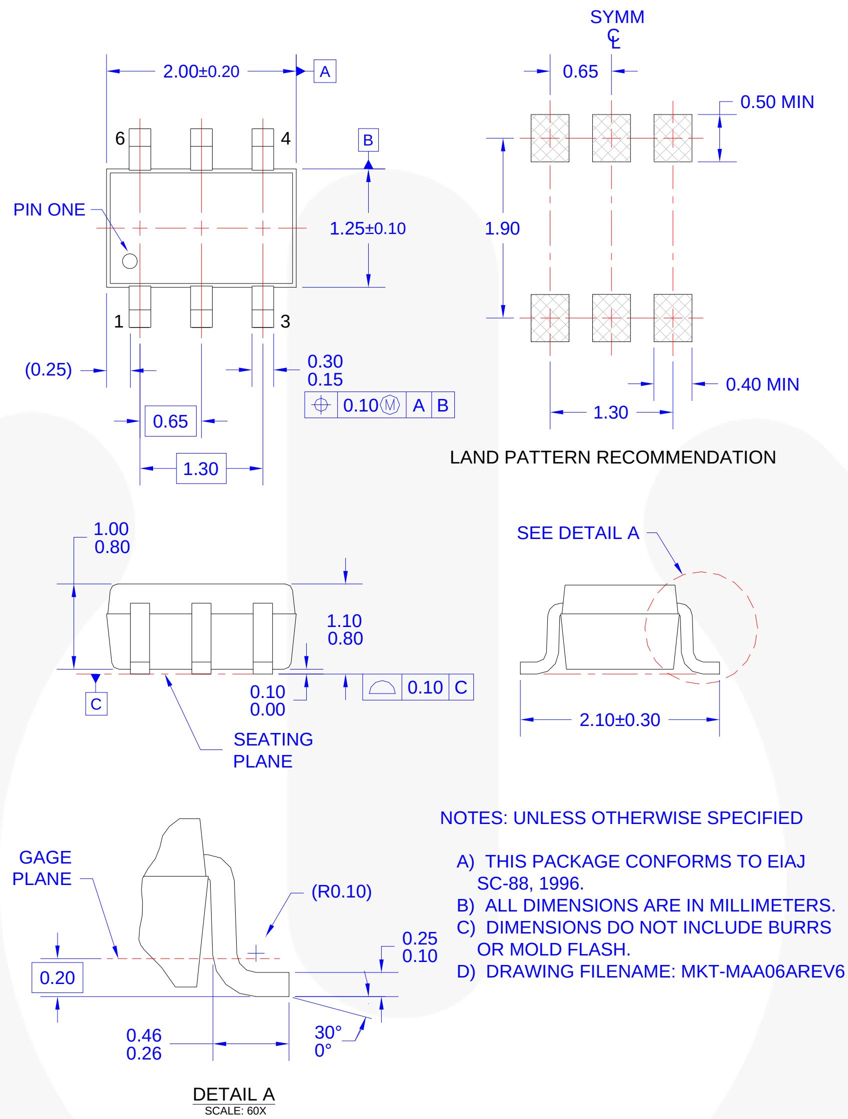


Figure 17. 6-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

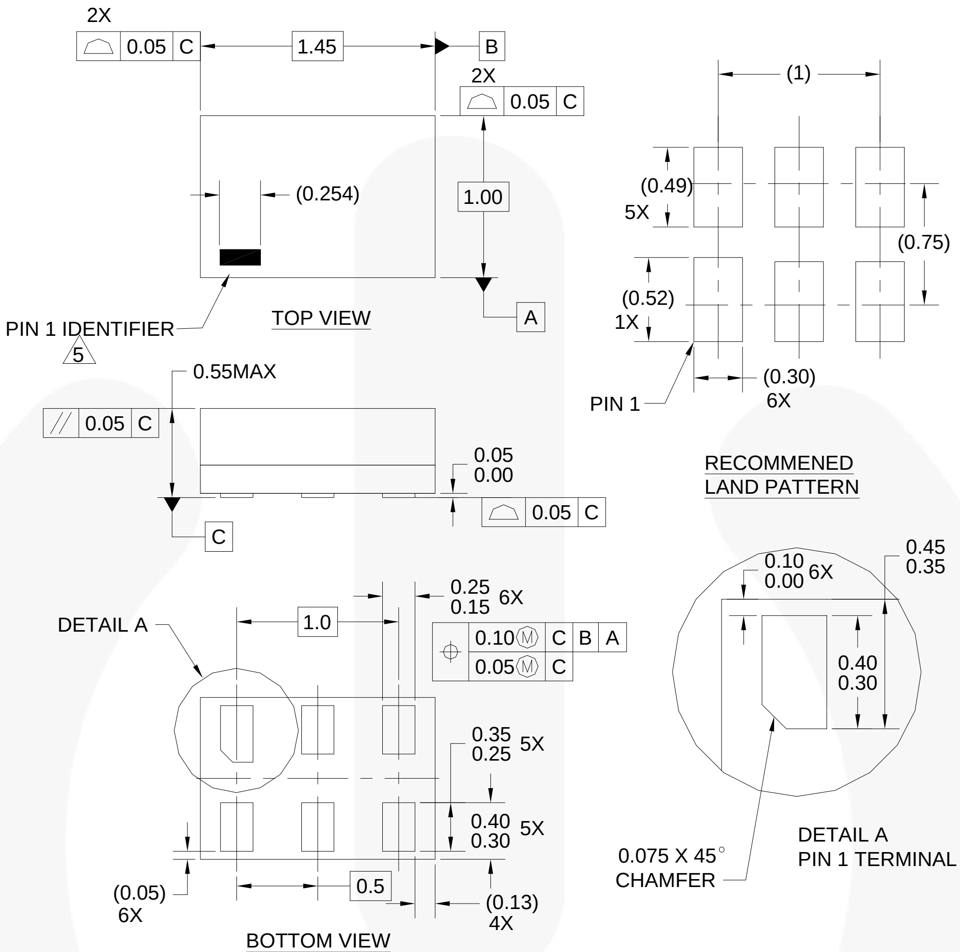
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.

Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/products/analog/pdf/sc70-6_tr.pdf

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994
4. FILENAME AND REVISION: MAC06AREV4
5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

Figure 18. 6-Lead, MicroPak™, 1.0mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.

Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
L6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions

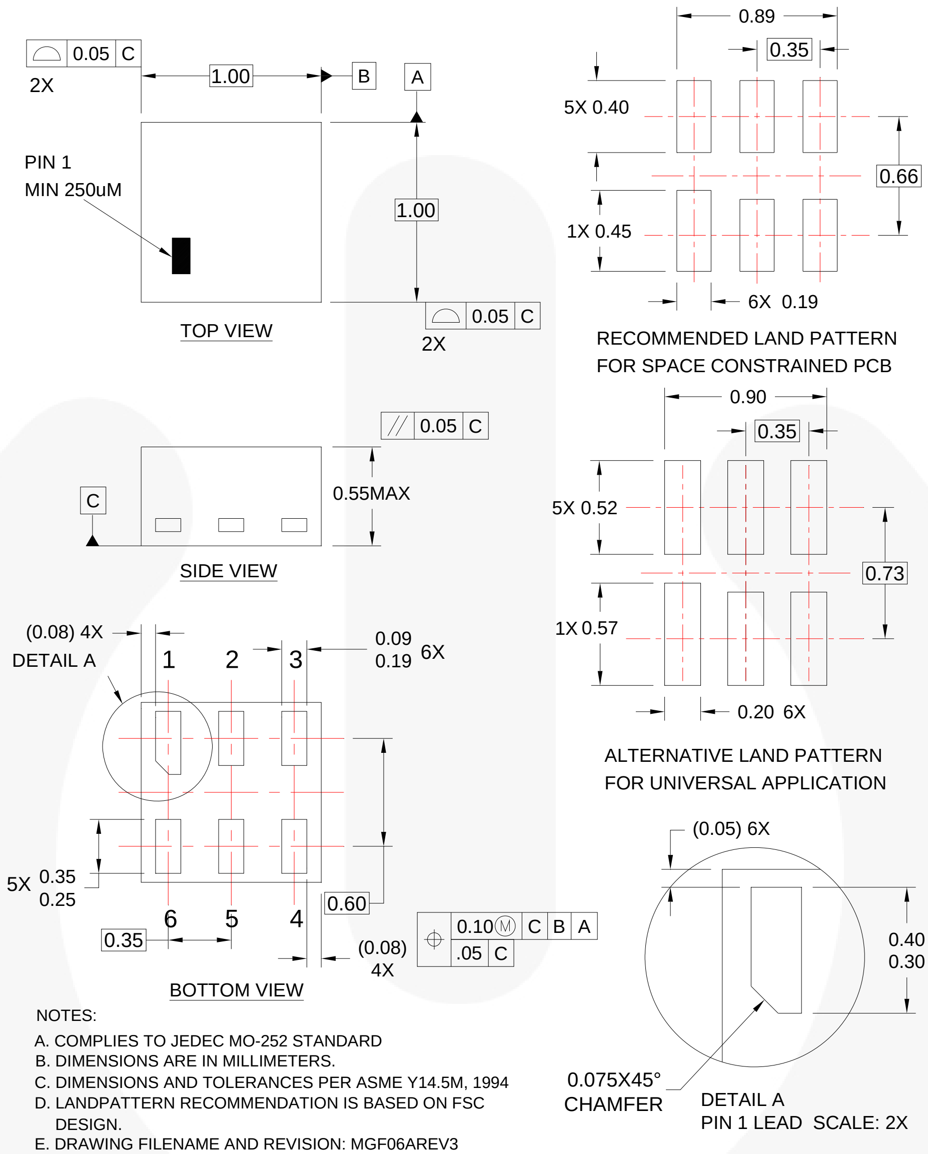


Figure 19. 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:
http://www.fairchildsemi.com/packaging/.

Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/packaging/MicroPAK2_6L_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

FAIRCHILD SEMICONDUCTOR®

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™
AccuPower™
Auto-SPM™
AX-CAP™*
BitSiC®
Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™
Current Transfer Logic™
DEUXPEED®
Dual Cool™
EcoSPARK®
EfficientMax™
ESBC™
F®
Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FastvCore™
FETBench™
FlashWriter®*
FPS™
F-PFS™
FRFET®
Global Power Resource℠
Green FPS™
Green FPS™ e-Series™
G*max*™
GTO™
IntelliMAX™
ISOPLANAR™
Making Small Speakers Sound Louder and Better™
MegaBuck™
MICROCOUPLER™
MicroFET™
MicroPak™
MicroPak2™
MillerDrive™
MotionMax™
Motion-SPM™
mWSaver™
OptoHiT™
OPTOLOGIC®
OPTOPLANAR®
®
PDP SPM™
Power-SPM™
PowerTrench®
PowerXS™
Programmable Active Droop™
QFET®
QS™
Quiet Series™
RapidConfigure™
™
Saving our world, 1mW/W/kW at a time™
SignalWise™
SmartMax™
SMART START™
SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™
SYSTEM GENERAL®*
The Power Franchise®
the power franchise
TinyBoost™
TinyBuck™
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC®
TriFault Detect™
TRUECURRENT®*
μSerDes™
μSerDes
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I57

Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.

Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.